



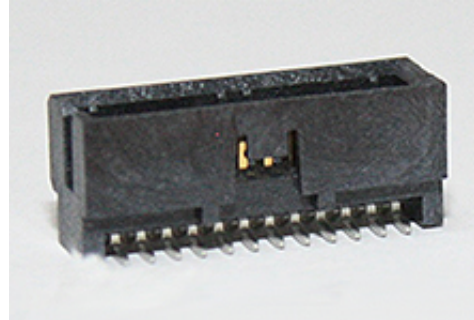
**Part Number :** [2009890012](#)

**Product Description :** Slim-Grid Header, 12 Circuits, Surface Mount, Vertical, Shrouded, 0.05µm Gold (Au) Plated, Tube, Lead-Free

**Series Number :** 200989

**Status :** New Business Not Supported

**Product Category :** Board-to-Board Connectors



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## Documents & Resources

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	
EU ELV	Compliant per 2000/53/EC
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)7663-DC (21 Jan 2025)
EU RoHS	Compliant per EU 2015/863

### Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

### Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### EU RoHS Certificate of Compliance

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## Part Details

### General

Status	New Business Not Supported
Category	Board-to-Board Connectors
Series	200989
Description	Slim-Grid Header, 12 Circuits, Surface Mount, Vertical, Shrouded, 0.05µm Gold (Au) Plated, Tube, Lead-Free
Application	Board-to-Board, Signal
Comments	4.3 Amps per Pole with only 1 contact powered up; 1.4 Amps per Pole with max contacts powered up
Component Type	PCB Header
Product Name	Slim-Grid
UPC	889056881203

#### Agency

CSA	LR19980
UL	E29179

#### Electrical

Current - Maximum per Contact	1.4A
Voltage - Maximum	125V AC

#### Physical

Breakaway	No
Circuits (Loaded)	12
Circuits (maximum)	12
Color - Resin	Black
Durability (mating cycles max)	500
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	Yes
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Gold

Material - Plating Termination	Matte Tin
Material - Resin	Liquid Crystal Polymer
Net Weight	0.409/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	None
Pitch - Mating Interface	1.27mm
Pitch - Termination Interface	1.27mm
Plating min - Mating	0.051µm
Plating min - Termination	2.000µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Shrouded	Fully
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

### Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260